

Fluorescence

GEMOLOGICAL INSTITUTE

ELECTRONIC COPY

LABORATORY GROWN DIAMOND REPORT

April 5, 2024	
IGI Report Number	LG628444177
Description	LABORATORY GROWN DIAMOND
Shape and Cutting Style	ROUND BRILLIANT
Measurements	6.89 - 6.93 X 4.22 MM
GRADING RESULTS	
Carat Weight	1.25 CARAT
Color Grade	D
Clarity Grade	VS 1
Cut Grade	IDEAL
ADDITIONAL GRADING INFORMA	TION
Polish	EXCELLENT
Symmetry	EXCELLENT

Inscription(s)	1/31 LG628444177

NONE

Comments: As Grown - No indication of post-growth treatment

This Laboratory Grown Diamond was created by High Pressure High Temperature (HPHT) growth process. Type II

LABORATORY GROWN DIAMOND REPORT

LG628444177 Report verification at igi.org

60%

Pointed

34.9°

40.9°

61.1%

PROPORTIONS

14%

43.5%

CLARITY CHARACTERISTICS

KEY TO SYMBOLS

Red symbols indicate internal characteristics.

Green symbols indicate external characteristics.

 \square

Medium To

Slightly Thick (Faceted)

LABORATORY GROWN DIAMOND REPORT

GRADING SCALES

CLARITY

IF	VVS ¹⁻²	VS ¹⁻²	SI ¹⁻²	l ¹⁻³
Internally	Very Very	Very	Slightly	Included
Flawless	Slightly Included	Slightly Included	Included	

COLOR

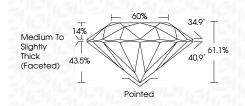
D E F G H I J Faint Very Light Ligh	D	FGH	ł I J	Faint	Very Light	Light
-------------------------------------	---	-----	-------	-------	------------	-------

16 LG628444177

Sample Image Used



April 5, 2024 IGI Report Number LG628444177 Description LABORATORY GROWN DIAMOND Shape and Cutting Style ROUND BRILLIANT Measurements 6.89 - 6.93 X 4.22 MM GRADING RESULTS Carat Weight 1.25 CARAT Color Grade D Clarity Grade VS 1 Cut Grade IDEAL



ADDITIONAL GRADING INFORMATION

Polish	EXCELLENT
Symmetry	EXCELLENT
Fluorescence	NONE
Inscription(s)	低到 LG628444177
Comments: As Grown - No indic treatment. This Laboratory Grown Diamono Pressure High Temperature (HPH Type II	d was created by High

G



THIS DOCUMENT WAS PRODUCED WITH THE FOLLOWING SECURITY MEASURES: SPECIAL DOCUMENT PAPER, INK SCREINS, WATERMARK BACKGROUND DESIGNS, HOLOGRAM AND OTHER SECURITY FEATURES NOT LISTED AND DO EXCEED DOCUMENT SECURITY INDUSTRY GUIDELINES.